



N-Channel 60-V (D-S) MOSFET

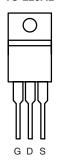
PRODUCT SUMMARY						
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)	Q _g (Typ.)			
60	0.006 at V _{GS} = 10 V	90 ^d	78.5			

FEATURES

- TrenchFET® Power MOSFET
- 175 °C Junction Temperature
- 100 % R_g and UIS Tested
- Compliant to RoHS Directive 2002/95/EC



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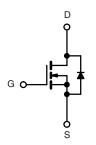


Top View

Ordering Information: SUP90N06-6m0P-E3 (Lead (Pb)-free)

APPLICATIONS

- Power Supply
 - Secondary Synchronous Rectification
- Industrial



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	T _C = 25 °C, unless oth	erwise noted		
Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V _{DS}	60	V	
Gate-Source Voltage	V _{GS}	± 20	7 v	
Continuous Drain Current (T _{.I} = 175 °C)	T _C = 25 °C	1-	90 ^d	
Continuous Diam Current (1) = 175 C)	T _C = 70 °C	I _D	90 ^d	A
Pulsed Drain Current	I _{DM}	240	_ A	
Avalanche Current		I _{AS}	50	
Single Avalanche Energy ^a	L = 0.1 mH	E _{AS}	125	mJ
Mariana Barra Birainatina	T _C = 25 °C	В	272 ^b	14/
Maximum Power Dissipation ^a	T _A = 25 °C ^c	P_{D}	3.75	W
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 175	°C

THERMAL RESISTANCE RATINGS					
Parameter	Symbol	Limit	Unit		
Junction-to-Ambient (PCB Mount) ^c	R _{thJA}	40	°C/W		
Junction-to-Case (Drain)	R _{thJC}	0.55	C/VV		

Notes:

- a. Duty cycle \leq 1 %.
- b. See SOA curve for voltage derating.c. When Mounted on 1" square PCB (FR-4 material).
- d. Package limited.

SUP90N06-6m0P

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SPECIFICATIONS T _J = 25 °C, unless otherwise noted							
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V_{DS}	$V_{DS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	60			V	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$	2.5		4.5	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 250	nA	
		$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}$			1		
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} = 60 V, V_{GS} = 0 V, T_{J} = 125 °C			50	μΑ	
		$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 150 ^{\circ}\text{C}$			250	1	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 10 \text{ V}, V_{GS} = 10 \text{ V}$	70			Α	
D : 0	D	V _{GS} = 10 V, I _D = 20 A		0.005	0.006	Ω	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 10 V, I _D = 20 A, T _J = 125 °C		0.008	0.010		
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 20 A		58		S	
Dynamic ^b							
Input Capacitance	C _{iss}			4700		pF	
Output Capacitance	C _{oss}	$V_{GS} = 0 \text{ V}, V_{DS} = 30 \text{ V}, f = 1 \text{ MHz}$		620			
Reverse Transfer Capacitance	C _{rss}			250			
Total Gate Charge ^c	Q_g			78.5	120		
Gate-Source Charge ^c	Q _{gs}	$V_{DS} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 50 \text{ A}$		28		nC	
Gate-Drain Charge ^c	Q_{gd}			20.6		1	
Gate Resistance	R_g	f = 1 MHz		1.2	2.4	Ω	
Turn-On Delay Time ^c	t _{d(on)}			16	30		
Rise Time ^c	t _r	V_{DD} = 30 V, R_L = 0.6 Ω		10	20		
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong 50 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		25	40	ns -	
Fall Time ^c	t _f			8	15		
Source-Drain Diode Ratings and Ch	aracteristics	T _C = 25 °C ^b					
Continuous Current	I _S	Is			85		
Pulsed Current	I _{SM}				240	Α	
Forward Voltage ^a	V_{SD}	I _F = 20 A, V _{GS} = 0 V		0.83	1.5	V	
Reverse Recovery Time	t _{rr}			62	100	ns	
Peak Reverse Recovery Current	I _{RM(REC)}	$I_F = 75 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}$		3.8	5.7	Α	
Reverse Recovery Charge	Q _{rr}			118	180	nC	

Notes:

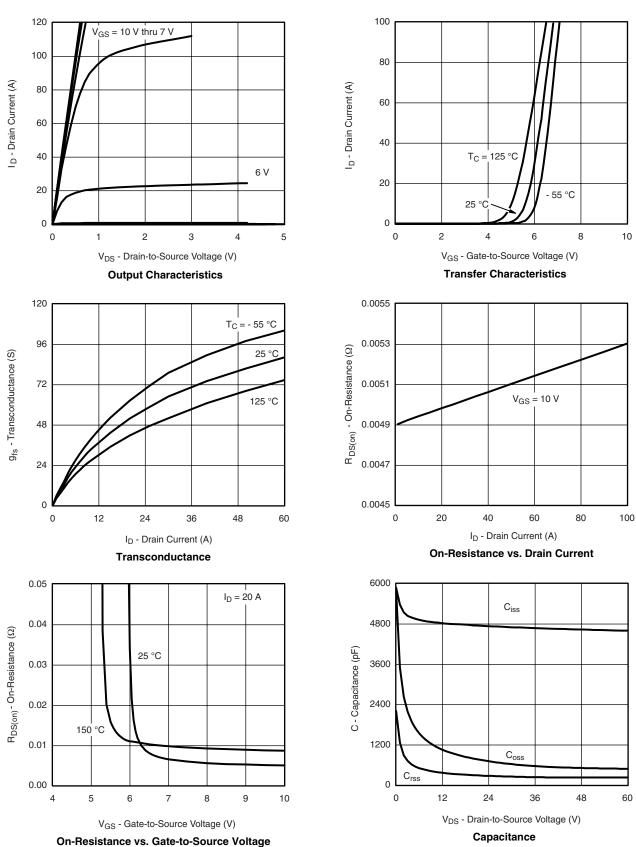
- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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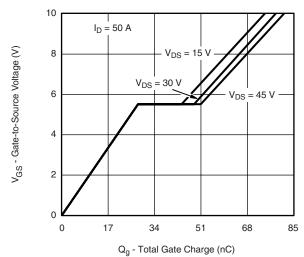
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



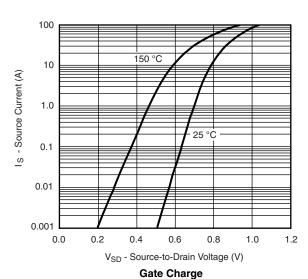
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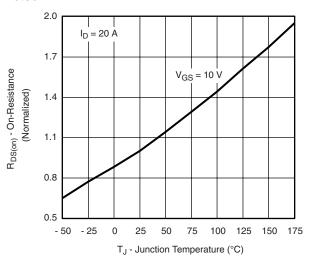


On-Resistance vs. Junction Temperature

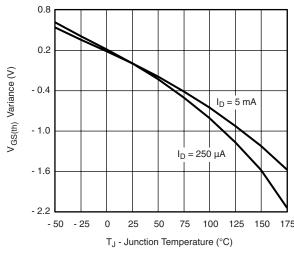


76 $I_D = 1 \text{ mA}$ 73 70 V_{DS} (normalized) 67 64 61 58 - 50 - 25 50 75 100 125 T_J - Junction Temperature (°C)

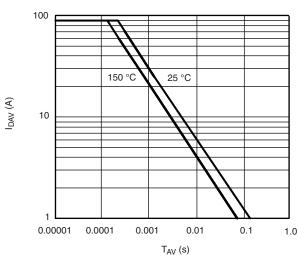
Source-Drain Diode Forward Voltage



Threshold Voltage



On-Resistance vs. Junction Temperature

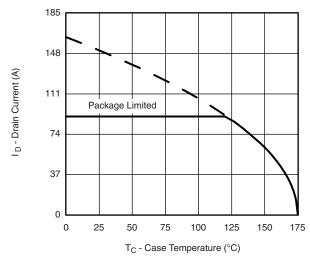


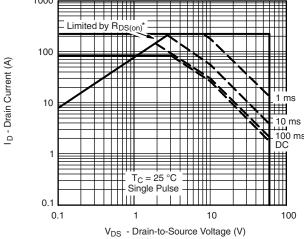
Maximum Drain Current vs. Case Temperature



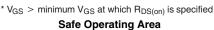
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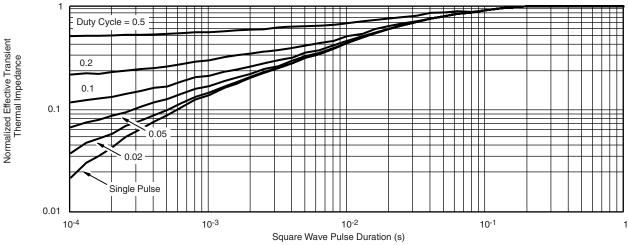
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





Single Pulse Avalanche Current Capability vs. Time





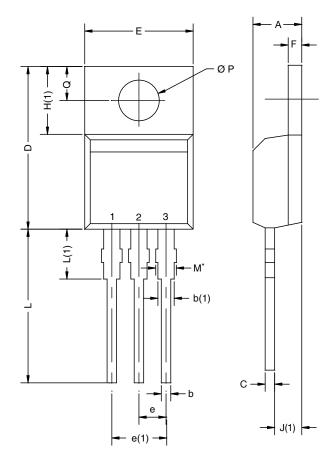
Normalized Thermal Transient Impedance, Junction-to-Case

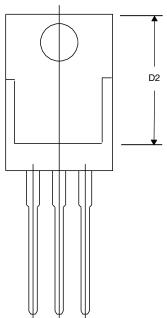
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	MILLIN	IETERS	INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
А	4.25	4.65	0.167	0.183	
b	0.69	1.01	0.027	0.040	
b(1)	1.20	1.73	0.047	0.068	
С	0.36	0.61	0.014	0.024	
D	14.85	15.49	0.585	0.610	
D2	12.19	12.70	0.480	0.500	
Е	10.04	10.51	0.395	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.09	6.48	0.240	0.255	
J(1)	2.41	2.92	0.095	0.115	
L	13.35	14.02	0.526	0.552	
L(1)	3.32	3.82	0.131	0.150	
ØΡ	3.54	3.94	0.139	0.155	
Q	2.60	3.00	0.102	0.118	
ECN: T14-0413-Rev. P, 16-Jun-14 DWG: 5471					

Note

 * M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM

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